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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

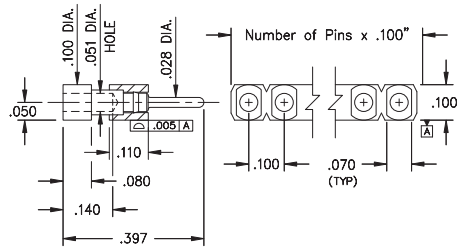
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



INTERCONNECTS

SERIES 800, 801, 830 • .100" GRID (.030" DIA. PINS), SURFACE MOUNT HEADERS AND SOCKETS • SINGLE ROW STRIPS

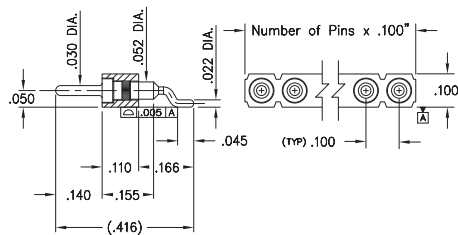
Mates with Series 801...002 Surface Mount Z-Bend Socket (See Fig. 3)



Coplanarity .005". For pin counts >10 positions, consult Technical Support.

FIG. 1

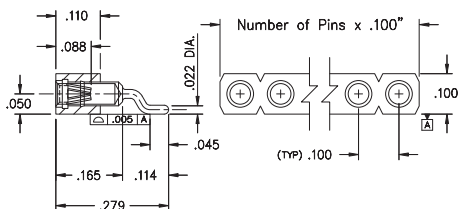
Mates with Series 801...002 Surface Mount Z-Bend Socket (See Fig. 3)



Coplanarity .005". For pin counts >10 positions, consult Technical Support.

FIG. 2

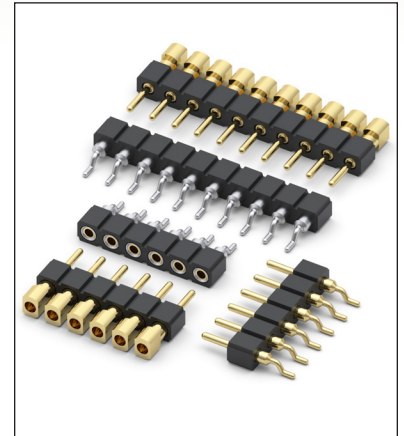
Mates with Series 800...002 and 830...028 Surface Mount Header (See Fig. 1 & 2)



Coplanarity .005". For pin counts >10 positions, consult Technical Support.

FIG. 3

- Series 800 horizontal surface mount headers are available with .028" dia. pluggable pins (MM #1502). Series 830 horizontal surface mount z-bend headers use MM #3028 pins. See page 224 for details
- Series 801 horizontal surface mount Z-Bend sockets uses MM #1303 receptacles that accept pin diameters from .025"-.037" and .025" square leads. See pages 180 for details
- Insulators are high temperature thermoplastic, suitable for all soldering operations
- Ideal for daisy chaining parallel boards



ORDERING INFORMATION









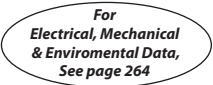





FIG. 1	Series 800...002 .028" Dia. Surface Mount Header
	800-10-0-40-002000 Specify number of pins 02-10
FIG. 2	Series 830...028 .030" Dia. Surface Mount Z-Bend Header
	830-XX-0-40-028000 Specify number of pins 02-10
  	
SPECIFY PLATING CODE XX=	
Pin Plating 	10  40 
	10 μ" Au 200 μ" Sn

FIG. 3	Series 801...002 .028" Dia. Surface Mount Z-Bend Socket
	801-XX-0-40-002000 Specify number of pins 02-10
  	
SPECIFY PLATING CODE XX=	
Sleeve (Pin) 	91 93 99 41  43  44 
Contact (Clip) 	200 μ" Sn/Pb 200 μ" Sn/Pb 200 μ" Sn/Pb 200 μ" Sn 200 μ" Sn 200 μ" Sn
	10 μ" Au 30 μ" Au 100 μ" Sn/Pb 10 μ" Au 30 μ" Au 100 μ" Sn

